

Vishay Siliconix

## P-Channel 30-V (D-S) MOSFET

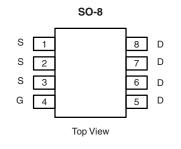
PRODUCT SUMMARY					
V <sub>DS</sub> (V)	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)		
- 30	0.005 at V <sub>GS</sub> = - 10 V	- 29	61 nC		
- 30	0.00775 at V <sub>GS</sub> = - 4.5 V	- 23	01110		

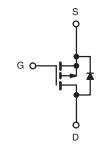
#### FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET<sup>®</sup> Power MOSFET
- 100 % R<sub>a</sub> and UIS Tested •
- Compliant to RoHS Directive 2002/95/EC

#### APPLICATIONS

- Adaptor Switch
- Notebook





P-Channel MOSFET

Ordering Information: Si4459ADY-T1-GE3 (Lead (Pb)-free and Halogen-free)

ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25 °C, unless otherwise noted) Parameter Symbol Limit Unit **Drain-Source Voltage** V<sub>DS</sub> - 30 ٧ Gate-Source Voltage V<sub>GS</sub> ± 20  $T_{C} = 25 \ ^{\circ}C$ - 29 T<sub>C</sub> = 70 °C - 23.5 Continuous Drain Current (T<sub>J</sub> = 150 °C)  $I_D$  $T_A = 25 \overline{^{\circ}C}$ - 19.7<sup>a, b</sup> T<sub>A</sub> = 70 °C - 15.6<sup>a, b</sup> А - 70 I<sub>DM</sub> Pulsed Drain Current T<sub>C</sub> = 25 °C - 6.5 Continuous Source-Drain Diode Current ls T<sub>A</sub> = 25 °C - 2.9<sup>a, b</sup> Avalanche Current  $I_{AS}$ - 30 L = 0.1 mHSingle-Pulse Avalanche Energy E<sub>AS</sub> 45 mJ T<sub>C</sub> = 25 °C 7.8 T<sub>C</sub> = 70 °C 5  $\mathsf{P}_\mathsf{D}$ Maximum Power Dissipation w T<sub>A</sub> = 25 °C 3.5<sup>a, b</sup> T<sub>A</sub> = 70 °C 2.2<sup>a, b</sup> Operating Junction and Storage Temperature Range T<sub>J</sub>, T<sub>stq</sub> - 55 to 150 °C

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	29	35	°C/W	
Maximum Junction-to-Foot	Steady State	R <sub>thJF</sub>	13	16	0/11	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

c. Maximum under steady state conditions is 80 °C/W.

d. Based on  $T_C = 25$  °C.

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b. t = 10 s.

# Si4459ADY

### Vishay Siliconix



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 V, I_D = -250 \mu A$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	l <sub>D</sub> = - 250 μA		- 31			
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	5 .		5.3		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = - 250 μA			- 2.5	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100		
		V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 100	nA	
Zava Cata Valtaga Drain Current	1	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 75		
Zero Gate Voltage Drain Current	IDSS	$V_{DS}$ = - 30 V, $V_{GS}$ = 0 V, $T_{J}$ = 75 °C			- 10		
		$V_{DS}$ = - 20 V, $V_{GS}$ = 0 V, $T_{J}$ = 75 °C			- 3	μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, \text{ V}_{GS} = -10 \text{ V}$	- 30			Α	
		V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 15 A		0.0039	0.005	Ω	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 10 A		0.0062	0.00775		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 15 A		24		S	
Dynamic <sup>b</sup>				•			
Input Capacitance	C <sub>iss</sub>			6000		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		860			
Reverse Transfer Capacitance	C <sub>rss</sub>			790			
Total Gate Charge	0	$V_{D0} = -15 V_{10} V_{00} = -10 V_{10} I_{0} = -20 A$		129	195	nC	
	$Q_g$			61	95		
Gate-Source Charge	$Q_gs$	$V_{DS}$ = - 15 V, $V_{GS}$ = - 4.5 V, $I_{D}$ = - 20 A		16.5			
Gate-Drain Charge	Q <sub>gd</sub>			23.5			
Gate Resistance	R <sub>g</sub>	f = 1 MHz	0.6	3	6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			16	30	-	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		16	30		
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		80	150		
Fall Time	t <sub>f</sub>			20	40		
Turn-On Delay Time	t <sub>d(on)</sub>			75	150	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 1.5 $\Omega$		130	260	-	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong$ - 10 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		60	120		
Fall Time	t <sub>f</sub>	, i i i i i i i i i i i i i i i i i i i		40	80		
Drain-Source Body Diode Characteris	stics			<b></b>			
Continous Source-Drain Diode Current	۱ <sub>s</sub>	T <sub>C</sub> = 25 °C			- 29		
Pulse Diode Forward Current	I <sub>SM</sub>	-			- 70	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.71	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			67	130	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 5 A, dl/dt = 100 A/μs, T <sub>J</sub> = 25 °C		74	150	nC	
Reverse Recovery Fall Time	ta			22			
Reverse Recovery Rise Time	t <sub>b</sub>			45		ns	

Notes:

a. Pulse test; pulse width  $\leq$  300 µs, duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

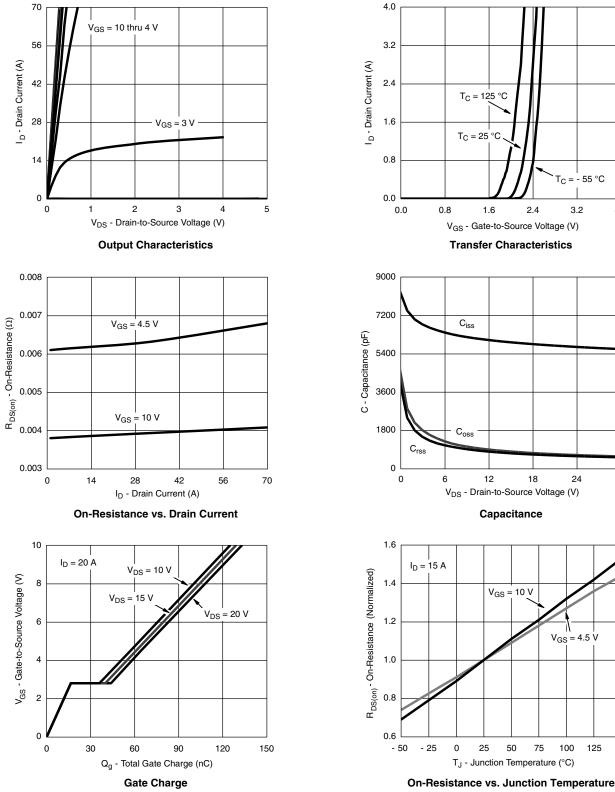
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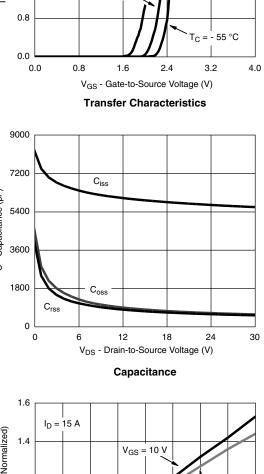
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## Si4459ADY Vishay Siliconix

#### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





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 $V_{GS} = 4.5 V$ 

125 150

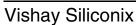
50

75

100

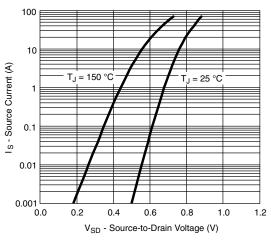
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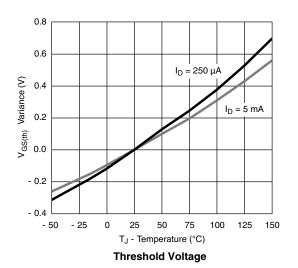


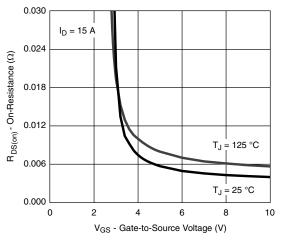


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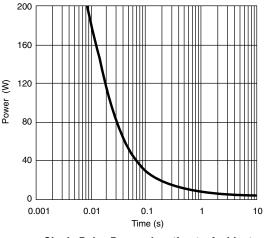


Source-Drain Diode Forward Voltage

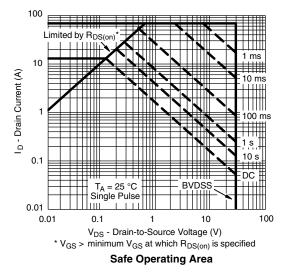




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient

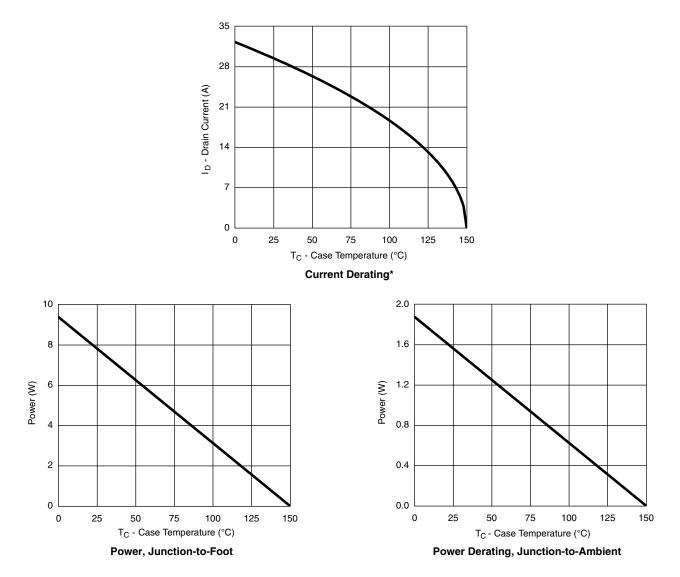


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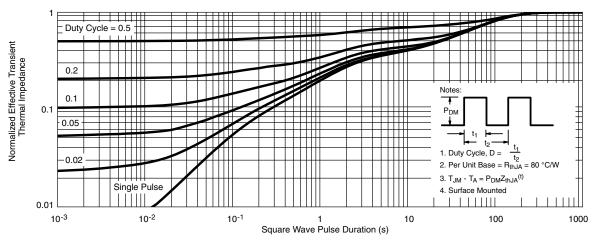
\* The power dissipation P<sub>D</sub> is based on T<sub>J(max)</sub> = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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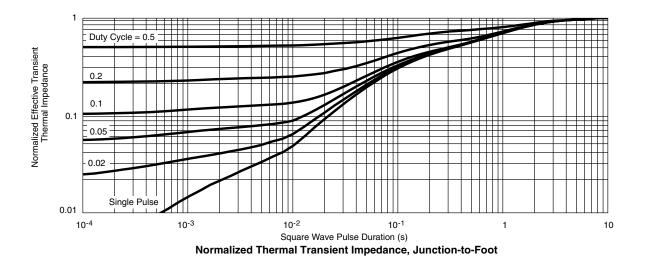


#### **Vishay Siliconix**

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Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg269979">www.vishay.com/ppg269979</a>.

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# Package Information

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# SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012





	MILLIM	IETERS	INC	HES	
DIM	Min	Мах	Min	Max	
A	1.35	1.75	0.053	0.069	
A <sub>1</sub>	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
E	3.80	4.00	0.150	0.157	
е	1.27 BSC		0.050 BSC		
н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I, 11-Sep-06 DWG: 5498					

# **Application Note 826**

Vishay Siliconix



**RECOMMENDED MINIMUM PADS FOR SO-8** 



Recommended Minimum Pads Dimensions in Inches/(mm)

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